Synthesis of Gallium Nitride and Related Oxides Via Ammonobasic Reactive Sublimation (ARS)

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Ammonobasic reactive sublimation (ARS) is proposed as a novel method to synthesize GaN and related oxides. Results indicate that GaN growth occurs by a nitriding process of Ga and related oxides, establishing a direct dependence on NH₄OH amount added as a primary chemical reactive. The samples were grown on p-type Si (111) substrates inside a tube furnace, employing GaN powder and NH₄OH. The characterizations of the samples were carried out by XRD, SEM, EDS and PL techniques, revealing the influence of NH₄OH on the improvement of GaN synthesis and the enhancement of its optical and structural properties.

Keywords: Gallium nitride, Sublimation, X-ray diffraction, Photoluminescence, Gallium oxide

1. Introduction

Nitride semiconductors (III-N) properties make them an excellent choice for the development of electronic, optoelectronic and spintronic devices, due to their direct bandgap and high chemical, mechanical and thermal stability¹. Nowadays growth technologies to obtain gallium nitride (GaN) thin films are based on epitaxial techniques, like metal-organic chemical vapor deposition (MOCVD) or molecular beam epitaxy (MBE). However, research based on non-epitaxial techniques, like reactive sputtering or ammonothermal reactions have been developed in order to achieve better results for the nitride semiconductor synthesis and enhancement of its properties.

Ammonothermal techniques are similar to our proposed method due to the employing of a furnace and use of ammonobasic compounds as precursors. However, these methods employed polycrystalline GaN as seeds in order to grow the material. Other specific growth parameters related to this method are, high ammonia (NH₃) pressure in the system (between 150-500 MPa), temperature in the range of 500-600 °C and a long growth time that could take several hours²⁻⁸. Optimization of the system in order to improve the growth rate and purity are in progress⁹⁻¹¹.

Santana et al. ^{12,13} demonstrated that GaN can be grown via the sublimation of GaN powders without any additional source of nitrogen (N), but the results indicate that the samples are nitrogen deficient. Moreover, in that work the growth temperature was limited by the use of a graphite

plate heated by infrared lamps. Taking into account those issues, we propose alternatively, the addition of ammonium hydroxide (NH $_4$ OH) as a compensation source of N and the use of a tube furnace for a better control of the temperature needed to synthesize GaN. Ammonium hydroxide has been selected due to its relatively easy handling and low-cost compared to common nitrogen sources of NH $_3$ and N $_2$ that require complementary and complex systems.

The growth of GaN thin films by the Ammonobasic Reactive Sublimation (ARS) is reported, this method is proposed as an alternative low-cost route employing a tube furnace. The ARS method is based on a sublimation technique that has high growth rate compared to ammonothermal techniques; it requires a low reactive ambient pressure and few precursors. To our knowledge few groups in the world are processing GaN by sublimation (either close spaced sublimation or closed space vapor transport), which in our case allowed the growth of GaN material, in spite of the fact that these techniques represent a fast non-thermal-equilibrium process, as compared to expensive techniques like MBE or MOCVD. The physical properties of the GaN synthesized by this process are improved by the employment of NH₄OH in comparison with previous results^{12,13}.

2. Experimental

Samples were grown on p-type Si (111) substrates, employing GaN powder (99.99% purity) and $\mathrm{NH_4OH}$ as precursors, all of them contained inside a graphite cell.

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The scheme of the graphite cell is shown in Fig. 1, this is composed by two pieces: 1) a substrate holder and powder container and 2) a cap. Holder and cap are tightly closed in a screw and nut configuration, these pieces join together to form a semi-hermetic container.

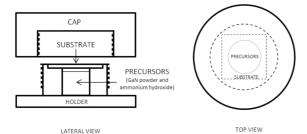


Figure 1. Scheme of the graphite cell. Semi-hermetic container constituted of two pieces: 1) a substrate holder and powder container and 2) a cap.

Ammonium hydroxide was added with an eyedropper and the amount varied in order to evaluate its function as nitrogen compensation source. However, the concentration was not accurately determined due to an apparent GaN permeability property and the high volatility of NH₄OH.

Concentrations can be estimated as follows. The holder has a volume of $\sim\!\!0.27~{\rm cm^3}$ that can contain a mixture of GaN powder ($\sim\!\!150~{\rm mg}$) and NH₄OH, close to the substrate surface (< 1 mm). The samples are labeled according to the NH₄OH amount employed, considering that each drop has a volume $\sim\!\!0.05~{\rm ml}$, the corresponding labels are presented in Table 1.

Table 1. Label of samples according to the amount of NH₂OH.

Sample	NH ₄ OH (ml)	GaN (mg)
S-0.10	0.10	150
S-0.15	0.15	150
S-0.20	0.20	150

The material growth was carried out inside a tube furnace, without any vacuum system or gas flow. The growth temperature was 1200 °C and the growth time 10 minutes. The growth time is shorter than the growth time employed with other techniques, which were of at least 1 hour ^{14,15}.

Structural analysis was carried out by X-ray diffraction (XRD) operating in grazing angle with a Cu- K_{α} radiation source (Bruker D8 advance). Morphology was examined by scanning electron microscopy (SEM, JEOL JSM-6300) equipped with an energy dispersive X-Ray spectrometer (EDS, Bruker XFlash 5010). Photoluminescence (PL) properties at room temperature were measured employing a He:Cd laser (λ =325 nm) as excitation source, a double monochromator (1403-SPEX) and a photomultiplier detector (RCA-C310334).

3. Results and Discussion

3.1 Structural, morphology and chemical analysis

The XRD patterns of the samples, S-0.10 and S-0.15, are shown in Fig. 2 (a) and (b) respectively. For these samples, diffraction peaks corresponded to the β -Ga₂O₃ phase (JCPDS¹ Card No. 041-1103) while for sample S-0.20, the peaks are clearly associated with a mixture of β -Ga₂O₃ and wurtzite GaN (indexed according to JCPDS Card No. 076-0703), as shown in Fig. 3.

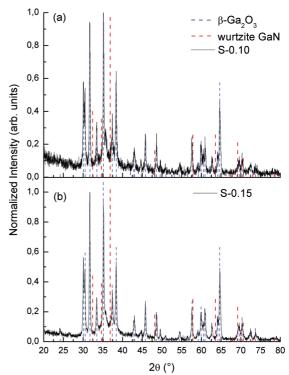


Figure 2. XRD diffraction patterns of samples: (a) S-0.10 and (b) S-0.15. The patterns of both samples are quite similar; however, sample S-0.15 has improved its crystallinity as compare to S-0.10. In sample S-0.15, the background intensity as well as the noise signal decreases.

A Rietveld analysis was performed in order to determine the phase fractions of β -Ga₂O₃ and GaN present in sample S-0.20. This analysis was carried out by employing the crystallographic information for the compounds GaN (ICSD^{II} 98-002-5676) and β -Ga₂O₃ (ICSD 98-003-4243) using the MAUD program^{III}. Results of this study are presented in Table 2

The SEM images of the samples are shown in Fig. 4 to 6. As it can be seen, morphology of samples S-0.10 (Fig. 4) and S-0.15 (Fig. 5) are quite similar, both of them exhibit the growth of some wire-like structures, which appear to be

¹ ICDD-PDF2 International Center for Diffraction Data - Powder Diffraction Patterns http://www.icdd.com

II ICSD - Inorganic Crystal Structure Database https://www.fiz-karlsruhe.de/en/leistungen/kristallographie/icsd.htm

III Materials Analysis Using Diffraction (MAUD) program http://maud.radiographema.com

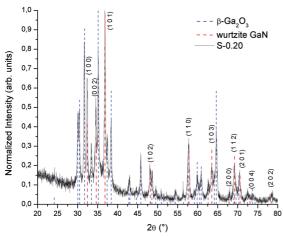


Figure 3. XRD diffraction pattern of sample S-0.20. Contrary to samples S-0.10 and S-0.15, the phase of GaN is completely identified and indexed; this evidences the influence of NH_4OH as a synthesis promoter of GaN by the ARS method.

Table 2. GaN and β -Ga₂O₃ phase fractions in sample S-0.20 according to Rietveld analysis.

	Weight fraction	Volume fraction
GaN	0.693	0.665
β -Ga $_2$ O $_3$	0.307	0.335

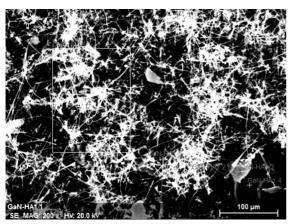


Figure 4. SEM image of sample S-0.10. An irregular morphology is observed, some particles and wire-like structures were grown on the substrate surface.

grouped by nodes or nucleation points. However, sample S-0.20 (Fig. 6) is completely different showing an agglomerate of irregular particles with many porous between them.

The average concentration of gallium and nitrogen according to EDS analysis for each sample are summarized in Table 3. It can be observed that S-0.10 and S-0.15 samples are non-stoichiometric, while S-0.20 sample is almost stoichiometric.

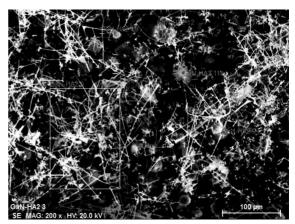


Figure 5. SEM image of sample S-0.15. The morphology is similar to sample S-0.10; however, the density of wire-like structures in samples S-0.15 is higher than that in S-0.10.

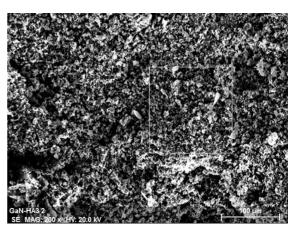


Figure 6. SEM image of sample S-0.20. Morphology of this is completely different, the density of wire-like structures appears to be null compared with samples S-0.10 and S-0.15.

3.2 Photoluminescence

The PL spectra obtained for samples S-0.10 and S0.20 exhibit a broad emission band from ~1.8 to 3.2 eV, having two clear maxima. Moreover, in the case of sample S-0.15 a shoulder on the high photon energy side can be also distinguished, which indicates another PL emission at high energy, above 3.0 eV. In order to assign the corresponding emissions, an iterative fitting process of the PL spectra was performed. The normalized room temperature photoluminescence spectrum of each GaN film and its related deconvoluted bands are shown in Fig.7. Two strong emission bands could be assigned, the first in the green region with a maximum at 2.37 eV, and the second one in the blue region with a maximum located between 2.75-2.85 eV depending on the sample. According to literature, the first emission labeled GL-2, is related to Ga-rich wurtzite GaN samples¹⁶, while

Table 3. Atomic concentration of Ga and N, determined by EDS, in samples S-0.10, S-0.15 and S-0.20

	Ga (at. %)	N (at. %)
S-0.10	81.46	18.54
S-0.15	67.01	32.99
S-0.20	48.04	51.96

the second is related to β -Ga₂O₃ nanostructures¹⁷; this means that a higher concentration of Ga in the samples is related to an increase in β -Ga₂O₃ phase growth. Additionally, sample S-0.15 shows a low intensity band around 3.04 eV related to the blue shifted emission that is associated with GaN samples contaminated with carbon (C-doped GaN)¹⁶.

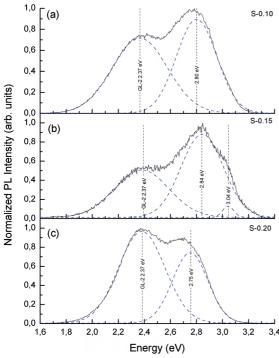


Figure 7. Normalized PL spectrum (black line) and its related deconvoluted bands (blue dash line) for samples: (a) S-0.10, (b) S-0.15 and (c) S-0.20. PL spectra of S-0.10 and S-0.15 are similar between them, which primary emission is related to β -Ga $_2$ O $_3$ nanowires, but S-0.15 also has a low intensity emission band related to C-doped GaN at 3.04 eV. However, the primary emission band in S-0.15 PL spectrum is the GL-2, contrary to samples S-0.10 and S-0.15.

3.3 Discussion

Samples S-0.10 and S-0.15 have similar properties, XRD indicates the growth of polycrystalline β -Ga $_2$ O $_3$ and SEM images exhibit the grow of wire-like structures over the sample surface. However, the density of these structures in S-0.10 is less than that in S-0.15. This can be related to the nitrogen concentration in the samples, suggesting a direct relation between the growth kinetics and the nitrogen concentration.

We considered that GaN small crystals act as nucleation centers for β -Ga $_2$ O $_3$ structures; then a higher nitrogen concentration provides a higher density of GaN nucleation centers and the growth rate of β -Ga $_2$ O $_3$ structures should increase. As we mention before, this sort of gallium oxide structures exhibit blue emission luminescence which is the principal emission in these samples. However, although there are no peaks in XRD patterns related to GaN, there must be some GaN growth on the surface which could be associated with the mentioned GL-2 emission.

The S-0.20 sample presents a very different surface morphology; notably there is an apparent absence of wire-like structures. The XRD pattern indicates the presence of polycrystalline GaN and $\beta\text{-}Ga_2\text{O}_3$. Therefore we assume that the top layers on the surface correspond to a $\beta\text{-}Ga_2\text{O}_3$ phase, while the inner layers beneath the surface are GaN. The increase of NH₄OH modifies the growth kinetics, implying a different surface morphology. The EDS results indicate a higher concentration of nitrogen in this sample, corresponding to XRD results. Additionally, the PL spectrum shows that the GL-2 band has a higher intensity than the band at 2.75 eV, contrary to samples S-0.10 and S-0.15.

Taking into account the previous considerations, we propose a general mechanism of growth for GaN synthesis via NH₂OH reactive sublimation. First, the ammonium hydroxide releases hydrogen due to the increase of temperature, the ammonium molecules start to dissociate into different complexes as NH₃, NH₂, NH and N₂, N, H₂, H¹⁴; assuming that there is an increase of the pressure inside of the semihermetic graphite cell as the temperature increases. This process will continue until the temperature reaches 1175°C, approximately, when the GaN begin to dissociate, leading to a second increase of the pressure into the chamber related to the release of nitrogen. Under these conditions of temperature and pressure, we assume that the vapor of water can reach a critical point and start to dissociate providing additional H and O. We consider that the effective growth time to be about 10 minutes after the moment when the temperature reaches 1200 °C. At this stage of the growth, Ga vapors are condensed on the Si surface and several reactions could take place, which involves the interactions between the C of the cell, the Si substrate and the Ga film already deposited on it, and also with the complexes of nitrogen, hydrogen and oxygen present in the growth cell.

According to our proposed synthesis process and taking into consideration similar reactions to those reported for the GaN synthesis by Nabi et al.¹⁵, the reaction stages inside the cell may be assumed as follows. Since the affinity of Ga and O is greater than that of Ga and N, we propose that after GaN dissociates β -Ga₂O₃ is synthesized, then this compound react in two ways:

1a) β -Ga₂O₃ reacts with C of the cell giving rise to a reaction that provides another kind of gallium oxide (Ga₂O) and carbon monoxide (CO):

$$Ga_2O_3 + 2C \rightarrow Ga_2O(g) + 2CO(g)$$

1b) β -Ga₂O₃ reacts simultaneously with the ammonia released after the dissociation of the ammonium hydroxide and the C of the cell, giving rise to GaN and CO:

$$Ga_2O_3 + 2NH_3(g) + 3C \rightarrow 2GaN + 3CO(g) + 3H_2(g)$$

The Ga₂O produced during the reaction 1a), could react with the other products released during the previous reactions in different ways:

2a) Due to a reduction process

$$Ga_2O(g) + CO(g) \rightarrow Ga(g) + Ga(l) + CO_2$$

2b) By the reaction with the N present inside the cell

$$Ga_2O(g) + 3N \rightarrow 2GaN + NO$$

According to the aforementioned reactions, we assumed that the graphite cell also reacts with precursors, in the same way as C reacts in the ammonothermal process. This will reduce the β -Ga₂O₃ and stimulate GaN synthesis. On other hand NH₃ and N are generated by the dissociation of NH₄OH and GaN.

The results indicate that sublimation is a viable route in order to synthesized GaN films. Our method proposed to use ammonium hydroxide as a nitrogen compensation source in order to achieve better films and improve its properties. Contrary to ammonothermal methods that employ GaN seeds to grow the samples, we use silicon (Si) substrates. These ammonothermal methods needs high ammonia pressures (> 100 MPa) while we use only a small amount of ammonium hydroxide (< 0.5 ml). We point out that ammonia is extremely caustic and hazardous compared to ammonium hydroxide; the handling of the reactive precursors and reaction products released during the growth process implies additional systems that increase the cost of the ammonothermal processes, on the other hand, the effective growth time of these methods is longer than 1 hr while the one we propose takes short times, of the order of 10 minutes only.

4. Conclusions

We can conclude that GaN film synthesis via ammonobasic reactive sublimation (ARS) is a promising low cost method because it increases the growth rate of polycrystalline GaN by a nitriding process of Ga and its related oxides; it requires the employing of GaN powder and NH₄OH as precursors.

It was possible to increase GaN growth while decreasing the β-Ga₂O₃ fraction with increasing NH₄OH concentration in the cell. The method does not require the assistance of conventional nitrogen compensation sources, like N2 and NH, fluxes at high pressure and with long exposure times. Contrary to ammonothermal methods, the ARS method requires only low concentrations of precursors GaN (< 0.200 g) and NH₄OH (< 0.5 ml) and short growth times (10 min). The XRD, SEM, EDS and PL measurements evidence the improvement of the optical and structural properties as the concentration of NH₄OH increases. Physical properties and growth rates of GaN films synthesized by ARS are improved compared with previous results obtained by close space vapor transport^{12,13}. Additionally, an intense white PL emission at room temperature was observed for all the films due to the contributions of the GL-2 band associated with GaN, and the blue band related to the β -Ga₂O₃ nanostructures.

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